

GPU SuperServer SYS-821GE-TNHR

Key Applications

High Performance Computing, AI/Deep Learning Training, Industrial Automation, Retail, Healthcare, Conversational AI, Business Intelligence & Analytics, Drug Discovery, Climate and Weather Modeling, Finance & Economics,

Key Features

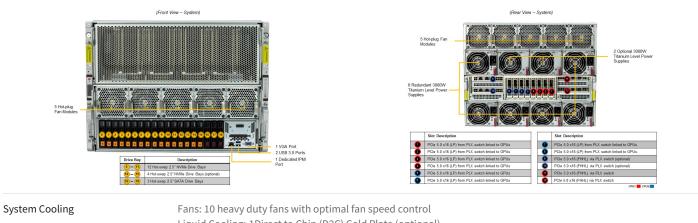
- 5th/4th Gen Intel® Xeon® Scalable processor support;
- 32 DIMM slots Up to 8TB: 32x 256 GB DRAM Memory Type: 5600MTs ECC DDR5;
- 8 PCIe Gen 5.0 X16 LP; 2 PCIe Gen 5.0 X16 FHHL Slots, 2 PCIe Gen 5.0 X16 FHHL Slots (optional);
- Flexible networking options;
- Optional: 8x 2.5" Hot-swap SATA drive bays; 16x 2.5" Hot-swap NVMe drive bays (12x by default, 4x optional); 2 M.2 NVMe for boot drive only; 3x 2.5" Hot-swap SATA drive bays;
- 10 heavy duty fans with optimal fan speed control;
- 6x 3000W (4+2) Redundant Power Supplies, Titanium Level; Optional: 8x 3000W (4+4) Redundant Power Supplies, Titanium Level;



	IPMI 2.0 with virtual media over LAN and KVM-over-LAN support	
	IPMI: Support for Intelligent Platform Management Interface v.2.0	
	2x 25GbE SFP28 with Broadcom® BCM57414 (optional) 2x 10GbE BaseT with Intel® X710-AT2 (optional)	
	Network Connectivity: 2x 10GbE BaseT with Intel® X550-AT2 (optional)	
On-Board Devices	Chipset: Intel® C741	
	4 PCIe 5.0 x16 FHHL slot(s)	
Expansion Slots	8 PCIe 5.0 x16 LP slot(s)	
	2 M.2 NVMe	
Drive Bays	19x 2.5" hot-swap NVMe/SATA drive bays (16x 2.5" NVMe dedicated)	
	Max Memory (2DPC): Up to 8TB 4400MT/s ECC DDR5 RDIMM	
	Max Memory (1DPC): Up to 4TB 5600MT/s ECC DDR5 RDIMM	
System Memory	Slot Count: 32 DIMM slots	
	GPU-GPU Interconnect: NVIDIA® NVLink® with NVSwitch™	
	CPU-GPU Interconnect: PCIe 5.0 x16 CPU-to-GPU Interconnect	
	Supported GPU: NVIDIA SXM: HGX H100 8-GPU (80GB)	
GPU	Max GPU Count: Up to 8 onboard GPU(s)	
	Up to 64C/128T; Up to 320MB Cache per CPU	
	Dual Socket E (LGA-4677) 5th Gen Intel® Xeon®/4th Gen Intel® Xeon® Scalable processors	
	Package: 698 x 750 x 1300mm (27.5" x 29.5" x 51.2")	
Form Factor	Enclosure: 437 x 355.6 x 843.28mm (17.2" x 14" x 33.2")	







	Liquid Cooling: 1Direct to Chip (D2C) Cold Plate (optional)
Power Supply	6x 3000W Redundant Titanium Level power supplies
System BIOS	BIOS Type: AMI 32MB SPI Flash EEPROM
Management	Redfish API; Supermicro Server Manager (SSM); Supermicro Power Manager (SPM); Supermicro Update Manager (SUM); SuperDoctor® 5; Super Diagnostics Offline ; KVM with dedicated LAN ; IPMI 2.0
PC Health Monitoring	CPU: Monitors for CPU Cores, Chipset Voltages, Memory 8+4 Phase-switching voltage regulator
	FAN: Fans with tachometer monitoring
	Status monitor for speed control
	Pulse Width Modulated (PWM) fan connectors
	Temperature: Monitoring for CPU and chassis environment
	Thermal Control for fan connectors
Dimensions and Weight	Height: 14" (355.6 mm)
	Width: 17.2" (437 mm)
	Depth: 33.2" (843.28 mm)
	Gross Weight: 225 lbs (102.1 kg)
	Net Weight: 166 lbs (75.3 kg)
	Packaging: 29.5" (H) x 27.5" (W) x 51.2" (D) Available Color: Black front & silver body
Operating Environment	Operating Temperature: 10°C ~ 35°C (50°F ~ 95°F)
	Non-operating Temperature: -40°C to 60°C (-40°F to 140°F)
	Operating Relative Humidity: 8% to 90% (non-condensing)
	Non-operating Relative Humidity: 5% to 95% (non-condensing)
Motherboard	Super X13DEG-OAD
Chassis	CSE-GP801TS